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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	eZ8
Core Size	8-Bit
Speed	20MHz
Connectivity	I ² C, IrDA, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	29
Program Memory Size	24KB (24K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Through Hole
Package / Case	40-DIP (0.620", 15.75mm)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f2421pm020eg

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Braces

The curly braces, { }, indicate a single register or bus created by concatenating some combination of smaller registers, buses, or individual bits.

- Example: The 12-bit register address {0H, RP[7:4], R1[3:0]} is composed of a 4-bit hexadecimal value (0H) and two 4-bit register values taken from the Register Pointer (RP) and Working Register R1. 0H is the most-significant nibble (4-bit value) of the 12-bit register, and R1[3:0] is the least significant nibble of the 12-bit register.

Parentheses

The parentheses, (), indicate an indirect register address lookup.

- Example: (R1) is the memory location referenced by the address contained in the Working Register R1.

Parentheses/Bracket Combinations

The parentheses, (), indicate an indirect register address lookup and the square brackets, [], indicate a register or bus.

- Example: Assume PC[15:0] contains the value 1234h. (PC[15:0]) then refers to the contents of the memory location at address 1234h.

Use of the Words *Set*, *Reset* and *Clear*

The word *set* implies that a register bit or a condition contains a logical 1. The words *reset* or *clear* imply that a register bit or a condition contains a logical 0. When either of these terms is followed by a number, the word *logical* may not be included; however, it is implied.

Notation for Bits and Similar Registers

A field of bits within a register is designated as: Register[n:n].

- Example: ADDR[15:0] refers to bits 15 through bit 0 of the Address.

Use of the Terms *LSB*, *MSB*, *lsb*, and *msb*

In this document, the terms *LSB* and *MSB*, when appearing in upper case, mean *least significant byte* and *most significant byte*, respectively. The lowercase forms, *lsb* and *msb*, mean *least significant bit* and *most significant bit*, respectively.

Use of Initial Uppercase Letters

Initial uppercase letters designate settings and conditions in general text.

- Example 1: The receiver forces the SCL line to Low.
- Example 2: The Master can generate a Stop condition to abort the transfer.

UART0 Control 1

U0CTL1 (F43H - Read/Write)

D7 D6 D5 D4 D3 D2 D1 D0

- Infrared Encoder/Decoder Enable
0 = Infrared endec is disabled
1 = Infrared endec is enabled
- Received Data Interrupt Enable
0 = Received data and errors generate interrupt requests
1 = Only errors generate interrupt requests. Received data does not.
- Baud Rate Registers Control
Refer to UART chapter for operation
- Driver Enable Polarity
0 = DE signal is active High
1 = DE signal is active Low
- Multiprocessor Bit Transmit
0 = Send a 0 as the multiprocessor bit
1 = Send a 1 as the multiprocessor bit
- Multiprocessor Mode [0]
See Multiprocessor Mode [1] below
- Multiprocessor (9-bit) Enable
0 = Multiprocessor mode is disabled
1 = Multiprocessor mode is enabled
- Multiprocessor Mode [1]
with Multiprocess Mode bit 0:
00 = Interrupt on all received bytes
01 = Interrupt only on address bytes
10 = Interrupt on address match and following data
11 = Interrupt on data following an address match

UART0 Status 1

U0STAT1 (F44H - Read Only)

D7 D6 D5 D4 D3 D2 D1 D0

- Multiprocessor Receive
Returns value of last multiprocessor bit
- New Frame
0 = Current byte is not start of frame
1 = Current byte is start of new frame
- Reserved

UART0 Address Compare

U0ADDR (F45H - Read/Write)

D7 D6 D5 D4 D3 D2 D1 D0

UART0 Address Compare [7:0]

UART0 Baud Rate Generator High Byte

U0BRH (F46H - Read/Write)

D7 D6 D5 D4 D3 D2 D1 D0

UART0 Baud Rate divisor [15:8]

UART0 Baud Rate Generator Low Byte

U0BRL (F47H - Read/Write)

D7 D6 D5 D4 D3 D2 D1 D0

UART0 Baud Rate divisor [7:0]

UART1 Transmit Data

U1TXD (F48H - Write Only)

D7 D6 D5 D4 D3 D2 D1 D0

UART1 transmitter data byte[7:0]

UART1 Receive Data

U1RXD (F48H - Read Only)

D7 D6 D5 D4 D3 D2 D1 D0

UART receiver data byte [7:0]

Stop Mode Recovery Using a GPIO Port Pin Transition HALT

Each of the GPIO Port pins may be configured as a Stop Mode Recovery input source. On any GPIO pin enabled as a Stop Mode Recovery source, a change in the input pin value (from High to Low or from Low to High) initiates Stop Mode Recovery. The GPIO Stop Mode Recovery signals are filtered to reject pulses less than 10 ns (typical) in duration. In the Watchdog Timer Control register, the STOP bit is set to 1.



Caution: *In STOP mode, the GPIO Port Input Data registers (PxIN) are disabled. The Port Input Data registers record the Port transition only if the signal stays on the Port pin through the end of the Stop Mode Recovery delay. Thus, short pulses on the Port pin can initiate Stop Mode Recovery without being written to the Port Input Data register or without initiating an interrupt (if enabled for that pin).*

Table 47. Watchdog Timer Approximate Time-Out Delays

WDT Reload Value (Hex)	WDT Reload Value (Decimal)	Approximate Time-Out Delay (with 10 kHz typical WDT oscillator frequency)	
		Typical	Description
000004	4	400 μ s	Minimum time-out delay
FFFFFF	16,777,215	1677.5 s	Maximum time-out delay

Watchdog Timer Refresh

When first enabled, the Watchdog Timer is loaded with the value in the Watchdog Timer Reload registers. The Watchdog Timer then counts down to 000000H unless a WDT instruction is executed by the eZ8[™] CPU. Execution of the WDT instruction causes the downcounter to be reloaded with the WDT Reload value stored in the Watchdog Timer Reload registers. Counting resumes following the reload operation.

When the 64K Series devices are operating in DEBUG Mode (through the On-Chip Debugger), the Watchdog Timer is continuously refreshed to prevent spurious Watchdog Timer time-outs.

Watchdog Timer Time-Out Response

The Watchdog Timer times out when the counter reaches 000000H. A time-out of the Watchdog Timer generates either an interrupt or a Reset. The WDT_RES Option Bit determines the time-out response of the Watchdog Timer. For information on programming of the WDT_RES Option Bit, see [Option Bits](#) on page 195.

WDT Interrupt in Normal Operation

If configured to generate an interrupt when a time-out occurs, the Watchdog Timer issues an interrupt request to the interrupt controller and sets the WDT status bit in the Watchdog Timer Control register. If interrupts are enabled, the eZ8 CPU responds to the interrupt request by fetching the Watchdog Timer interrupt vector and executing code from the vector address. After time-out and interrupt generation, the Watchdog Timer counter rolls over to its maximum value of FFFFFFFH and continues counting. The Watchdog Timer counter is not automatically returned to its Reload Value.

WDT Interrupt in STOP Mode

If configured to generate an interrupt when a time-out occurs and the 64K Series devices are in STOP mode, the Watchdog Timer automatically initiates a Stop Mode Recovery and generates an interrupt request. Both the WDT status bit and the STOP bit in the Watchdog Timer Control register are set to 1 following WDT time-out in STOP mode. For more information on Stop Mode Recovery, see [Reset and Stop Mode Recovery](#) on page 47.

Receiver Interrupts

The receiver generates an interrupt when any of the following occurs:

- A data byte has been received and is available in the UART Receive Data register. This interrupt can be disabled independent of the other receiver interrupt sources. The received data interrupt occurs once the receive character has been received and placed in the Receive Data register. Software must respond to this received data available condition before the next character is completely received to avoid an overrun error.

► **Note:** *In MULTIPROCESSOR mode ($MPEN = 1$), the receive data interrupts are dependent on the multiprocessor configuration and the most recent address byte.*

- A break is received
- An overrun is detected
- A data framing error is detected

UART Overrun Errors

When an overrun error condition occurs the UART prevents overwriting of the valid data currently in the Receive Data register. The Break Detect and Overrun status bits are not displayed until after the valid data has been read.

After the valid data has been read, the UART Status 0 register is updated to indicate the overrun condition (and Break Detect, if applicable). The `RDA` bit is set to 1 to indicate that the Receive Data register contains a data byte. However, because the overrun error occurred, this byte may not contain valid data and should be ignored. The `BRKD` bit indicates if the overrun was caused by a break condition on the line. After reading the status byte indicating an overrun error, the Receive Data register must be read again to clear the error bits in the UART Status 0 register. Updates to the Receive Data register occur only when the next data word is received.

UART Data and Error Handling Procedure

Figure 18 on page 113 displays the recommended procedure for use in UART receiver interrupt service routines.

Table 59. UART Baud Rate High Byte Register (UxBRH)

BITS	7	6	5	4	3	2	1	0
FIELD	BRH							
RESET	1							
R/W	R/W							
ADDR	F46H and F4EH							

Table 60. UART Baud Rate Low Byte Register (UxBRL)

BITS	7	6	5	4	3	2	1	0
FIELD	BRL							
RESET	1							
R/W	R/W							
ADDR	F47H and F4FH							

For a given UART data rate, the integer baud rate divisor value is calculated using the following equation:

$$\text{UART Baud Rate Divisor Value (BRG)} = \text{Round}\left(\frac{\text{System Clock Frequency (Hz)}}{16 \times \text{UART Data Rate (bits/s)}}\right)$$

The baud rate error relative to the desired baud rate is calculated using the following equation:

$$\text{UART Baud Rate Error (\%)} = 100 \times \left(\frac{\text{Actual Data Rate} - \text{Desired Data Rate}}{\text{Desired Data Rate}}\right)$$

For reliable communication, the UART baud rate error must never exceed 5 percent.

[Table 61](#) provides information on data rate errors for popular baud rates and commonly used crystal oscillator frequencies.



Table 61. UART Baud Rates (Continued)

9.60	23	9.73	1.32	9.60	12	9.60	0.00
4.80	47	4.76	-0.83	4.80	24	4.80	0.00
2.40	93	2.41	0.23	2.40	48	2.40	0.00
1.20	186	1.20	0.23	1.20	96	1.20	0.00
0.60	373	0.60	-0.04	0.60	192	0.60	0.00
0.30	746	0.30	-0.04	0.30	384	0.30	0.00

During an SPI transfer, data is sent and received simultaneously by both the Master and the Slave SPI devices. Separate signals are required for data and the serial clock. When an SPI transfer occurs, a multi-bit (typically 8-bit) character is shifted out one data pin and a multi-bit character is simultaneously shifted in on a second data pin. An 8-bit shift register in the Master and another 8-bit shift register in the Slave are connected as a circular buffer. The SPI shift register is single-buffered in the transmit and receive directions. New data to be transmitted cannot be written into the shift register until the previous transmission is complete and receive data (if valid) has been read.

SPI Signals

The four basic SPI signals are:

- [Master-In/Slave-Out](#)
- [Master-Out/Slave-In](#)
- [Serial Clock](#)
- [Slave Select](#)

Each signal is described in both Master and Slave modes.

Master-In/Slave-Out

The Master-In/Slave-Out (MISO) pin is configured as an input in a Master device and as an output in a Slave device. It is one of the two lines that transfer serial data, with the most significant bit sent first. The MISO pin of a Slave device is placed in a high-impedance state if the Slave is not selected. When the SPI is not enabled, this signal is in a high-impedance state.

Master-Out/Slave-In

The Master-Out/Slave-In (MOSI) pin is configured as an output in a Master device and as an input in a Slave device. It is one of the two lines that transfer serial data, with the most significant bit sent first. When the SPI is not enabled, this signal is in a high-impedance state.

Serial Clock

The Serial Clock (SCK) synchronizes data movement both in and out of the device through its MOSI and MISO pins. In MASTER mode, the SPI's Baud Rate Generator creates the serial clock. The Master drives the serial clock out its own SCK pin to the Slave's SCK pin. When the SPI is configured as a Slave, the SCK pin is an input and the clock signal from the Master synchronizes the data transfer between the Master and Slave devices. Slave devices ignore the SCK signal, unless the \overline{SS} pin is asserted. When configured as a slave, the SPI block requires a minimum SCK period of greater than or equal to 8 times the system (XIN) clock period.

SSIO—Slave Select I/O

0 = \overline{SS} pin configured as an input.

1 = \overline{SS} pin configured as an output (Master mode only).

SSV—Slave Select Value

If SSIO = 1 and SPI configured as a Master:

0 = \overline{SS} pin driven Low (0).

1 = \overline{SS} pin driven High (1).

This bit has no effect if SSIO = 0 or SPI configured as a Slave.

SPI Diagnostic State Register

The SPI Diagnostic State register ([Table 67](#)) provides observability of internal state. This is a read only register used for SPI diagnostics.

Table 67. SPI Diagnostic State Register (SPIDST)

BITS	7	6	5	4	3	2	1	0
FIELD	SCKEN	TCKEN	SPISTATE					
RESET	0							
R/W	R							
ADDR	F64H							

SCKEN—Shift Clock Enable

0 = The internal Shift Clock Enable signal is deasserted

1 = The internal Shift Clock Enable signal is asserted (shift register is updates on next system clock)

TCKEN—Transmit Clock Enable

0 = The internal Transmit Clock Enable signal is deasserted.

1 = The internal Transmit Clock Enable signal is asserted. When this is asserted the serial data out is updated on the next system clock (MOSI or MISO).

SPISTATE—SPI State Machine

Defines the current state of the internal SPI State Machine.

Table 74. I²C Baud Rate Low Byte Register (I2CBRL)

BITS	7	6	5	4	3	2	1	0
FIELD	BRL							
RESET	FFH							
R/W	R/W							
ADDR	F54H							

BRL = I²C Baud Rate Low Byte
Least significant byte, BRG[7:0], of the I²C Baud Rate Generator's reload value.

► **Note:** *If the DIAG bit in the I²C Diagnostic Control Register is set to 1, a read of the I2CBRL register returns the current value of the I²C Baud Rate Counter[7:0].*

I²C Diagnostic State Register

The I²C Diagnostic State register (Table 75) provides observability of internal state. This is a read only register used for I²C diagnostics and manufacturing test.

Table 75. I²C Diagnostic State Register (I2CDST)

BITS	7	6	5	4	3	2	1	0
FIELD	SCLIN	SDAIN	STPCNT	TXRXSTATE				
RESET	X		0					
R/W	R							
ADDR	F55H							

SCLIN—Value of Serial Clock input signal

SDAIN—Value of the Serial Data input signal

STPCNT—Value of the internal Stop Count control signal

TXRXSTATE—Value of the internal I²C state machine

DMAx_IO[7:0]}. When the DMA is configured for two-byte word transfers, the DMAx I/O Address register must contain an even numbered address.

Table 78. DMAx I/O Address Register (DMAxIO)

BITS	7	6	5	4	3	2	1	0
FIELD	DMA_IO							
RESET	X							
R/W	R/W							
ADDR	FB1H, FB9H							

DMA_IO—DMA on-chip peripheral control register address
This byte sets the low byte of the on-chip peripheral control register address on Register File Page FH (addresses F00H to FFFH).

DMAx Address High Nibble Register

The DMAx Address High register ([Table 79](#)) specifies the upper four bits of address for the Start/Current and End Addresses of DMAx.

Table 79. DMAx Address High Nibble Register (DMAxH)

BITS	7	6	5	4	3	2	1	0
FIELD	DMA_END_H				DMA_START_H			
RESET	X							
R/W	R/W							
ADDR	FB2H, FBAH							

DMA_END_H—DMAx End Address High Nibble
These bits, used with the DMAx End Address Low register, form a 12-bit End Address. The full 12-bit address is given by {DMA_END_H[3:0], DMA_END[7:0]}.

DMA_START_H—DMAx Start/Current Address High Nibble
These bits, used with the DMAx Start/Current Address Low register, form a 12-bit Start/Current Address. The full 12-bit address is given by {DMA_START_H[3:0], DMA_START[7:0]}.

0 = DMA0 is not the source of the interrupt from the DMA Controller.

1 = DMA0 completed transfer of data to/from the End Address and generated an interrupt.

ADC Control Register Definitions

ADC Control Register

The ADC Control register selects the analog input channel and initiates the analog-to-digital conversion.

Table 86. ADC Control Register (ADCCTL)

BITS	7	6	5	4	3	2	1	0
FIELD	CEN	Reserved	VREF	CONT	ANAIN[3:0]			
RESET	0		1	0				
R/W	R/W							
ADDR	F70H							

CEN—Conversion Enable

0 = Conversion is complete. Writing a 0 produces no effect. The ADC automatically clears this bit to 0 when a conversion has been completed.

1 = Begin conversion. Writing a 1 to this bit starts a conversion. If a conversion is already in progress, the conversion restarts. This bit remains 1 until the conversion is complete.

Reserved—Must be 0.

$\overline{\text{VREF}}$

0 = Internal voltage reference generator enabled. The VREF pin should be left unconnected (or capacitively coupled to analog ground) if the internal voltage reference is selected as the ADC reference voltage.

1 = Internal voltage reference generator disabled. An external voltage reference must be provided through the VREF pin.

CONT

0 = Single-shot conversion. ADC data is output once at completion of the 5129 system clock cycles.

1 = Continuous conversion. ADC data updated every 256 system clock cycles.

ANAIN—Analog Input Select

These bits select the analog input for conversion. Not all Port pins in this list are available in all packages for the Z8F642x family Z8R642x family of products. For information on the Port pins available with each package style, see [Signal and Pin Descriptions](#) on page 7. Do not enable unavailable analog inputs.

0000 = ANA0

0001 = ANA1

0010 = ANA2

0011 = ANA3

Reserved

These bits are reserved and must be 0.

FSTAT—Flash Controller Status

00_0000 = Flash Controller locked

00_0001 = First unlock command received

00_0010 = Second unlock command received

00_0011 = Flash Controller unlocked

00_0100 = Flash Sector Protect register selected

00_1xxx = Program operation in progress

01_0xxx = Page erase operation in progress

10_0xxx = Mass erase operation in progress

Page Select Register

The Page Select (FPS) register (Table 94) selects one of the 128 available Flash memory pages to be erased or programmed. Each Flash Page contains 512 bytes of Flash memory. During a Page Erase operation, all Flash memory locations with the 7 most significant bits of the address given by the PAGE field are erased to FFH.

The Page Select register shares its Register File address with the Flash Sector Protect Register. The Page Select register cannot be accessed when the Flash Sector Protect register is enabled.

Table 94. Page Select Register (FPS)

BITS	7	6	5	4	3	2	1	0
FIELD	INFO_EN	PAGE						
RESET	0							
R/W	R/W							
ADDR	FF9H							

INFO_EN—Information Area Enable

0 = Information Area is not selected.

1 = Information Area is selected. The Information area is mapped into the Flash Memory address space at addresses FE00H through FFFFH.

PAGE—Page Select

This 7-bit field selects the Flash memory page for Programming and Page Erase operations. Flash Memory Address[15:9] = PAGE[6:0].

Oscillator Operation with an External RC Network

The External RC oscillator mode is applicable to timing insensitive applications.

Figure 41 displays a recommended configuration for connection with an external resistor-capacitor (RC) network.

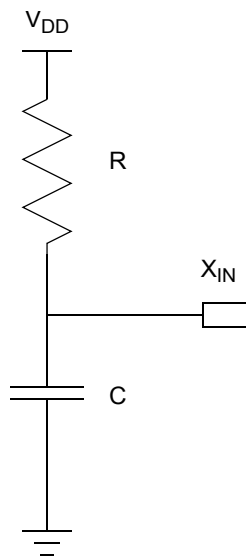


Figure 41. Connecting the On-Chip Oscillator to an External RC Network

An external resistance value of 45 kΩ is recommended for oscillator operation with an external RC network. The minimum resistance value to ensure operation is 40 kΩ. The typical oscillator frequency can be estimated from the values of the resistor (R in kΩ) and capacitor (C in pF) elements using the following equation:

$$\text{Oscillator Frequency (kHz)} = \frac{1 \times 10^6}{(0.4 \times R \times C) + (4 \times C)}$$

Figure 42 displays the typical (3.3 V and 25 °C) oscillator frequency as a function of the capacitor (C in pF) employed in the RC network assuming a 45 kΩ external resistor. For very small values of C , the parasitic capacitance of the oscillator XIN pin and the printed circuit board should be included in the estimation of the oscillator frequency.

It is possible to operate the RC oscillator using only the parasitic capacitance of the package and printed circuit board. To minimize sensitivity to external parasitics, external capacitance values in excess of 20 pF are recommended.

DC Characteristics

Table 106 lists the DC characteristics of the 64K Series products. All voltages are referenced to V_{SS} , the primary system ground.

Table 106. DC Characteristics

Symbol	Parameter	$T_A = -40\text{ }^{\circ}\text{C to }125\text{ }^{\circ}\text{C}$			Units	Conditions
		Minimum	Typical	Maximum		
V_{DD}	Supply Voltage	3.0	–	3.6	V	
V_{IL1}	Low Level Input Voltage	-0.3	–	$0.3 \cdot V_{DD}$	V	For all input pins except $\overline{\text{RESET}}$, DBG, XIN
V_{IL2}	Low Level Input Voltage	-0.3	–	$0.2 \cdot V_{DD}$	V	For $\overline{\text{RESET}}$, DBG, and XIN.
V_{IH1}	High Level Input Voltage	$0.7 \cdot V_{DD}$	–	5.5	V	Port A, C, D, E, F, and G pins.
V_{IH2}	High Level Input Voltage	$0.7 \cdot V_{DD}$	–	$V_{DD} + 0.3$	V	Port B and H pins.
V_{IH3}	High Level Input Voltage	$0.8 \cdot V_{DD}$	–	$V_{DD} + 0.3$	V	$\overline{\text{RESET}}$, DBG, and XIN pins
V_{OL1}	Low Level Output Voltage Standard Drive	–	–	0.4	V	$I_{OL} = 2\text{ mA}$; $V_{DD} = 3.0\text{ V}$ High Output Drive disabled.
V_{OH1}	High Level Output Voltage Standard Drive	2.4	–	–	V	$I_{OH} = -2\text{ mA}$; $V_{DD} = 3.0\text{ V}$ High Output Drive disabled.
V_{OL2}	Low Level Output Voltage High Drive	–	–	0.6	V	$I_{OL} = 20\text{ mA}$; $V_{DD} = 3.3\text{ V}$ High Output Drive enabled $T_A = -40\text{ }^{\circ}\text{C to }+70\text{ }^{\circ}\text{C}$
V_{OH2}	High Level Output Voltage High Drive	2.4	–	–	V	$I_{OH} = -20\text{ mA}$; $V_{DD} = 3.3\text{ V}$ High Output Drive enabled; $T_A = -40\text{ }^{\circ}\text{C to }+70\text{ }^{\circ}\text{C}$
V_{OL3}	Low Level Output Voltage High Drive	–	–	0.6	V	$I_{OL} = 15\text{ mA}$; $V_{DD} = 3.3\text{ V}$ High Output Drive enabled; $T_A = +70\text{ }^{\circ}\text{C to }+105\text{ }^{\circ}\text{C}$
V_{OH3}	High Level Output Voltage High Drive	2.4	–	–	V	$I_{OH} = 15\text{ mA}$; $V_{DD} = 3.3\text{ V}$ High Output Drive enabled; $T_A = +70\text{ }^{\circ}\text{C to }+105\text{ }^{\circ}\text{C}$
V_{RAM}	RAM Data Retention	0.7	–	–	V	
I_{IL}	Input Leakage Current	-5	–	+5	μA	$V_{DD} = 3.6\text{ V}$; $V_{IN} = V_{DD}\text{ or }V_{SS}^1$
I_{TL}	Tri-State Leakage Current	-5	–	+5	μA	$V_{DD} = 3.6\text{ V}$

Figure 47 displays the maximum current consumption in STOP mode with the VBO and Watchdog Timer enabled versus the power supply voltage. All GPIO pins are configured as outputs and driven High.

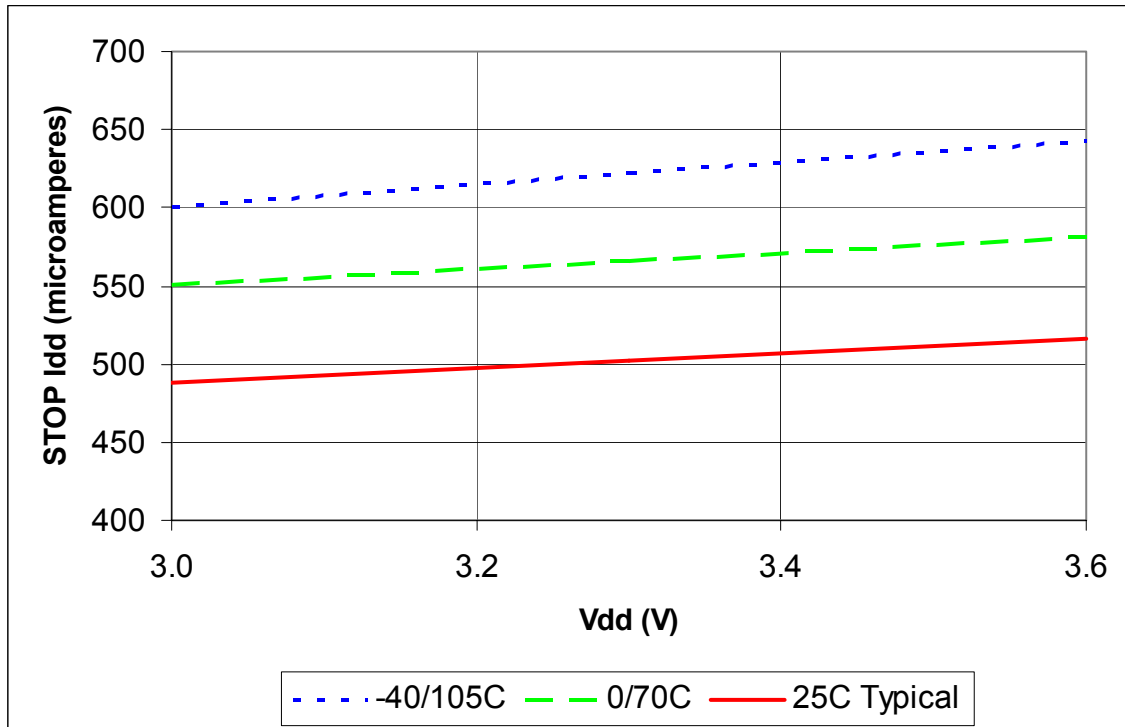


Figure 47. Maximum STOP Mode Idd with VBO enabled versus Power Supply Voltage

General-Purpose I/O Port Input Data Sample Timing

Figure 50 displays timing of the GPIO Port input sampling. Table 114 lists the GPIO port input timing.

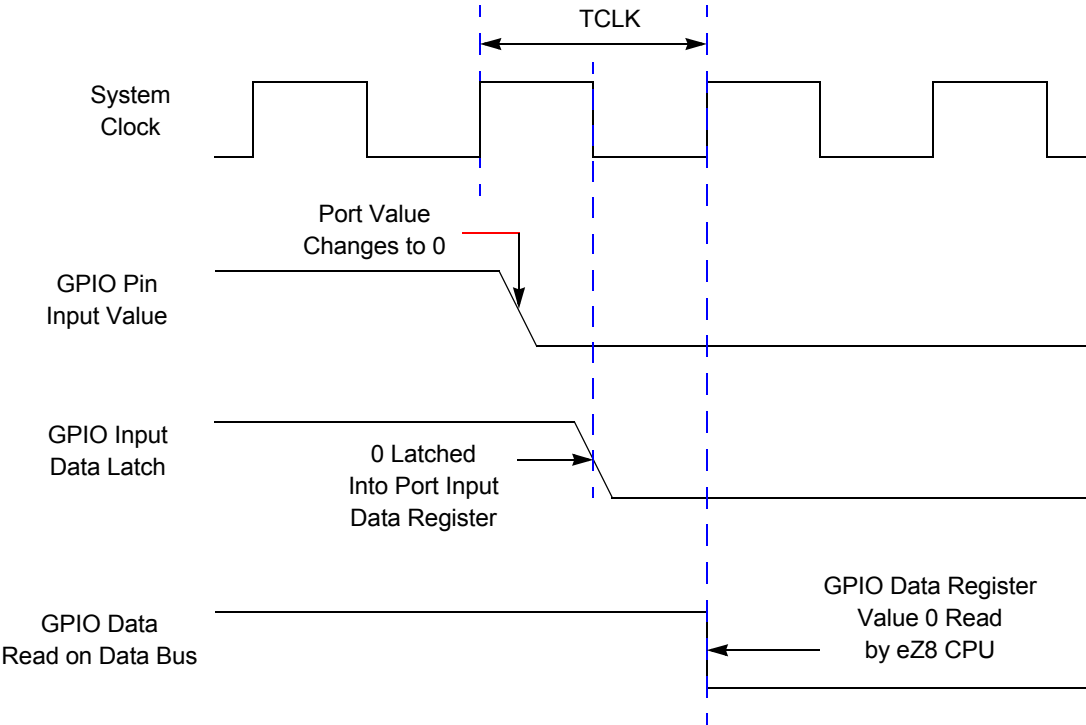


Figure 50. Port Input Sample Timing

Table 114. GPIO Port Input Timing

Parameter	Abbreviation	Delay (ns)	
		Min	Max
T _{S_PORT}	Port Input Transition to XIN Fall Setup Time (Not pictured)	5	–
T _{H_PORT}	XIN Fall to Port Input Transition Hold Time (Not pictured)	6	–
T _{SMR}	GPIO Port Pin Pulse Width to Insure Stop Mode Recovery (for GPIO Port Pins enabled as SMR sources)	1 μs	

UART Timing

Figure 56 and Table 120 provide timing information for UART pins for the case where the Clear To Send input pin ($\overline{\text{CTS}}$) is used for flow control. In this example, it is assumed that the Driver Enable polarity has been configured to be Active Low and is represented here by $\overline{\text{DE}}$. The $\overline{\text{CTS}}$ to $\overline{\text{DE}}$ assertion delay (T_1) assumes the UART Transmit Data register has been loaded with data prior to $\overline{\text{CTS}}$ assertion.

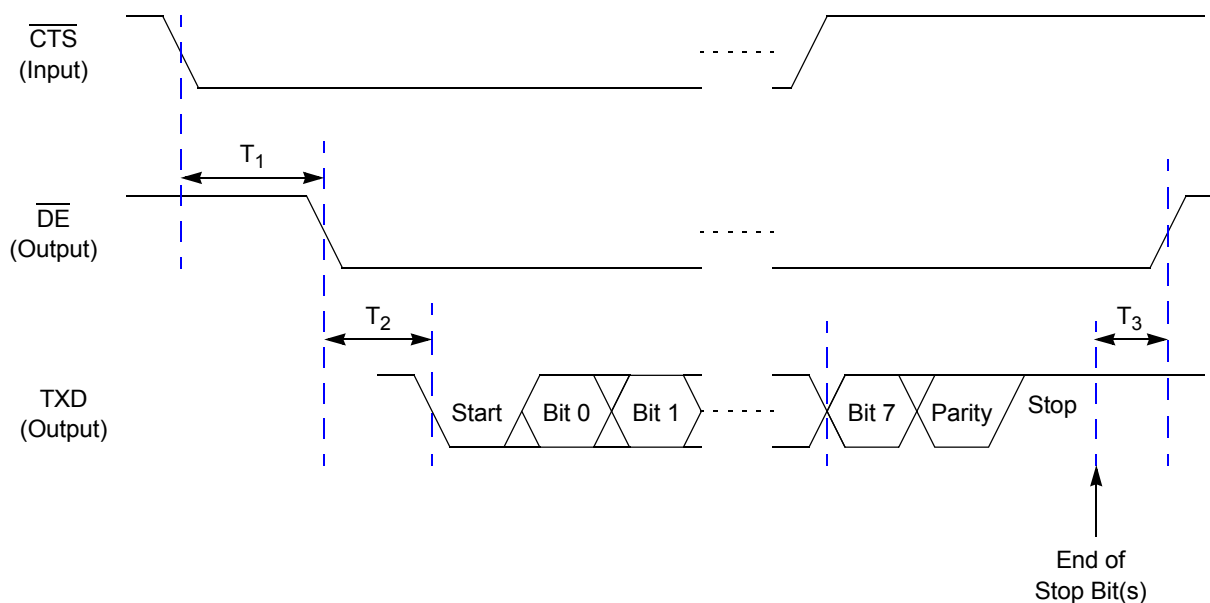


Figure 56. UART Timing with $\overline{\text{CTS}}$

Table 120. UART Timing with $\overline{\text{CTS}}$

Parameter	Abbreviation	Delay (ns)	
		Minimum	Maximum
T_1	$\overline{\text{CTS}}$ Fall to $\overline{\text{DE}}$ Assertion Delay	2 * XIN period	2 * XIN period + 1 Bit period
T_2	$\overline{\text{DE}}$ Assertion to TXD Falling Edge (Start) Delay	1 Bit period	1 Bit period + 1 * XIN period
T_3	End of Stop Bit(s) to $\overline{\text{DE}}$ Deassertion Delay	1 * XIN period	2 * XIN period